

**Improving long-term stability of the $\text{CH}_3\text{NH}_3\text{PbI}_3$ – based solar cells
by RT-ALD- Al_2O_3 film**

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Since few years, many efforts have been done to keep the initial efficiency of the perovskite solar cells over a long time. The $\text{CH}_3\text{NH}_3\text{PbI}_3$ -based solar cells have shown an increased long-term stability against ambient conditions while encapsulating them or covering the perovskite film by a thin Al_2O_3 film. Although the solar cells stability with the Al_2O_3 film could be successfully improved it has not lasted for a long time.

In this paper, we will present that by covering the $\text{CH}_3\text{NH}_3\text{PbI}_3$ film with a room temperature atomic layer deposited Al_2O_3 (RT-ALD- Al_2O_3) [1,2] one cannot only increase the stability, but more interestingly, one can boost the efficiency of solar cells over time. In particular, the $\text{Al}_2\text{O}_3/\text{CH}_3\text{NH}_3\text{PbI}_3$ interface is characterized using the X-ray Photoemission Spectroscopy (XPS) and Field Emission Scanning Electron Microscopy (FESEM). The efficiency of the Au/Spiro-OMeTAD/(RT-ALD- Al_2O_3)/ $\text{CH}_3\text{NH}_3\text{PbI}_3$ /PCBM/ TiO_2 /ITO/glass solar cells are extracted from the current density-voltage (J-V) characteristics measured under AM1.5G light at 100 Wcm^{-2} . As deduced from the XPS and FESEM studies the ALD precursors only clean the perovskite surface from the $-\text{OH}$ groups and do not change its composition. Most importantly, the average efficiency of the solar cells containing 9 RT-ALD- Al_2O_3 cycles increases from 9.4 to 10.8 % but without the RT-ALD layer it decreases from 13.6 to 9.6 % while storing both in the same environmental conditions for 355 days. It is supposed that the excitonic states present in the Al_2O_3 film help to maintain the device fill factor on a constant level over a long time.

[1] M. Kot et al., ChemSusChem 9 (2016) 3401.

[2] M. Kot et al., Nucl. Instrum. Methods Phys. Res. B 411 (2017) 49.